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**Technical Literature B-01** 

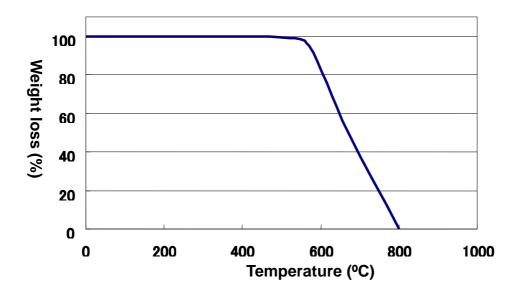
## Thermal Decomposition Properties of AURUM®

AURUM<sup>®</sup> is very thermally stable, showing the thermal decomposition properties that are better than those of PEEK, a representative high-performance resin. A thermal decomposition curve (DTG) is shown in Fig. 1.

In a short time, AURUM<sup>®</sup> suffers little or no weight loss up to a temperature level of approximately 500°C - 1% weight loss (Td1) at 520°C and 5% weight loss (Td5) at 570°C - exhibiting the best thermal decomposition properties out of all heat resistant resins.

			(°C)
	Td1	Td5	Td50
AURUM®	520	570	670
PEEK	480	520	610

Fig. 1 Thermal Decomposition Curve of AURUM®



The information contained herein is based on the information and data available at this moment, but none of the data or evaluation results contained herein provide any warranty whatsoever.